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Advanced Mechanical Design and Applications of Metamaterials

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Message from the Guest Editors

Metamaterials have introduced novel concepts and exciting functionalities that are beyond the traditional constraints imposed by natural materials, including negative refractive index media, microwave perfect absorber, invisibility cloaking, phase gradient metasurface, etc., some of which have already been realized and applied in practical applications. Nowadays, metamaterials have been employed at the interfacial and structural levels as well. Multi-physical properties like mechanical and dynamic responses have been considered in the design strategies of multifunctional metamaterials. For instance, sound attenuation, microwave absorber, and energy transduction require additional mechanical properties, such as being lightweight, load-bearing, as well as having environmental resistance.

This Special Issue aims to highlight state-of-the-art theories, mechanisms, configurations, and fabrication techniques in this field.













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Editor-in-Chief

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Message from the Editor-in-Chief

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